### SN54AHC16374, SN74AHC16374 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

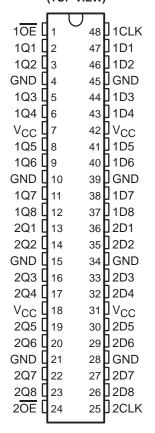
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- **Members of the Texas Instruments** Widebus™ Family
- **EPIC™** (Enhanced-Performance Implanted **CMOS) Process**
- Operating Range 2-V to 5.5-V V<sub>CC</sub>
- 3-State Outputs Drive Bus Lines Directly
- Distributed V<sub>CC</sub> and GND Pins Minimize **High-Speed Switching Noise**
- Flow-Through Architecture Optimizes PCB Layout
- Latch-Up Performance Exceeds 250 mA Per **JESD 17**
- **ESD Protection Exceeds 2000 V Per** MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- **Package Options Include Plastic Shrink** Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package **Using 25-mil Center-to-Center Spacings**

#### description

The 'AHC16374 devices 16-bit are edge-triggered D-type flip-flops with 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

SN54AHC16374 . . . WD PACKAGE SN74AHC16374 . . . DGG. DGV. OR DL PACKAGE (TOP VIEW)



These devices can be used as two 8-bit flip-flops or one 16-bit flip-flop. On the positive transition of the clock (CLK) input, the Q outputs of the flip-flop take on the logic levels at the data (D) inputs.

A buffered output-enable  $(\overline{OE})$  input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines without need for interface or pullup components.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

OE does not affect internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

The SN54AHC16374 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74AHC16374 is characterized for operation from -40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

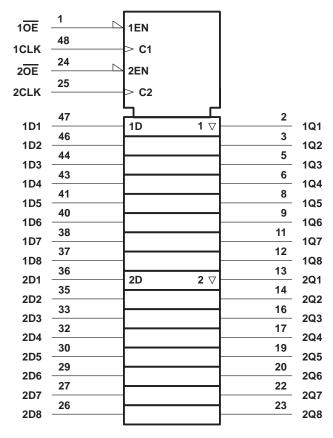
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## FUNCTION TABLE (each 8-bit flip-flop)

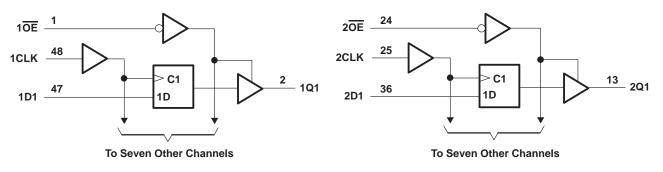
	INPUTS	ОИТРИТ	
OE	CLK	D	Q
L	1	Н	Н
L	$\uparrow$	L	L
L	H or L	Χ	Q <sub>0</sub>
Н	Х	Χ	Z

### logic symbol†



<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram (positive logic)





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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)	–0.5 V to 7 V
Output voltage range, V <sub>O</sub> (see Note 1)	$\dots$ -0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–20 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )	±20 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	±25 mA
Continuous current through each V <sub>CC</sub> or GND	±75 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 2): DGG package	70°C/W
DGV package	58°C/W
DL package	63°C/W
Storage temperature range, T <sub>Sto</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.

#### recommended operating conditions (see Note 3)

			SN54AH	C16374	SN74AH0	C16374	UNIT	
			MIN	MAX	MIN	MAX	UNII	
Vсс	Supply voltage		2	5.5	2	5.5	V	
		V <sub>CC</sub> = 2 V	1.5		1.5			
VIН	High-level input voltage	V <sub>CC</sub> = 3 V	2.1		2.1		V	
		V <sub>CC</sub> = 5.5 V	3.85		3.85			
		V <sub>CC</sub> = 2 V		0.5		0.5		
VIL	Low-level input voltage	V <sub>CC</sub> = 3 V		0.9		0.9	V	
		V <sub>CC</sub> = 5.5 V		1.65		1.65		
٧ı	Input voltage	-	0.0	5.5	0	5.5	V	
٧o	Output voltage		.0	Vcc	0	Vcc	V	
		V <sub>CC</sub> = 2 V	20	-50		<del>-</del> 50	μΑ	
ЮН	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$	8	-4		-4	mA	
		$V_{CC} = 5 V \pm 0.5 V$		-8		-8	mA	
		V <sub>CC</sub> = 2 V		50		50	μΑ	
lOL	Low-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		4		4	A	
		$V_{CC} = 5 V \pm 0.5 V$		8		8	mA	
A4/A		$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		100		100	//	
Δt/Δv	Input transition rise or fall rate $\frac{CC}{VCC} = 5 \text{ V} \pm 0.5 \text{ V}$			20		20	ns/V	
T <sub>A</sub>	Operating free-air temperature	·	-55	125	-40	85	°C	

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

### SN54AHC16374, SN74AHC16374 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

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## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS	Vaa	T,	4 = 25°C	;	SN54AHC	16374	SN74AHC16374		UNIT
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
		2 V	1.9	2		1.9		1.9		
	I <sub>OH</sub> = -50 μA	3 V	2.9	3		2.9		2.9		
Voн		4.5 V	4.4	4.5		4.4		4.4		V
	I <sub>OH</sub> = -4 mA	3 V	2.58			2.48		2.48		
	I <sub>OH</sub> = -8 mA	4.5 V	3.94			3.8	N.	3.8		
		2 V			0.1		0.1		0.1	
	I <sub>OL</sub> = 50 μA	3 V			0.1	40	0.1		0.1	
VOL		4.5 V			0.1	40	0.1		0.1	V
	I <sub>OL</sub> = 4 mA	3 V			0.36	20	0.5		0.44	
	I <sub>OL</sub> = 8 mA	4.5 V			0.36	Ogy	0.5		0.44	
Ι <sub>Ι</sub>	$V_I = V_{CC}$ or GND	0 V to 5.5 V			±0.1	y	±1*		±1	μΑ
loz	VO = VCC or GND	5.5 V			±0.25		±2.5		±2.5	μΑ
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		40		40	μΑ
C <sub>i</sub>	$V_I = V_{CC}$ or GND	5 V		2.5	10				10	pF
Co	$V_O = V_{CC}$ or GND	5 V		3.5						pF

 $<sup>^{*}</sup>$  On products compliant to MIL-PRF-38535, this parameter is not production tested at  $V_{CC} = 0 \text{ V}$ .

## timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

		T <sub>A</sub> = 2	T <sub>A</sub> = 25°C		SN54AHC16374		SN74AHC16374	
		MIN	MAX	MIN	MAX	MIN	MAX	UNIT
t <sub>W</sub>	Pulse duration, CLK high or low	5		5.5	5.74	5.5		ns
t <sub>su</sub>	Setup time, data before CLK↑	4.5		4	lik.	4		ns
t <sub>h</sub>	Hold time, data after CLK↑	2		2		2		ns

# timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

		T <sub>A</sub> = 2	T <sub>A</sub> = 25°C		SN54AHC16374		16374	UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	L
t <sub>W</sub>	Pulse duration, CLK high or low	5		5	N. N	5		ns
t <sub>su</sub>	Setup time, data before CLK↑	3		3		3		ns
t <sub>h</sub>	Hold time, data after CLK↑	2		2		2		ns

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# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T,	Δ = 25°C	;	SN54AH0	C16374	SN74AHC	16374	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII	
f			C <sub>L</sub> = 15 pF	80*	130*		70*		70		MHz	
f <sub>max</sub>			C <sub>L</sub> = 50 pF	55	85		50		50		IVITIZ	
<sup>t</sup> PLH	CLK	Q	C <sub>I</sub> = 15 pF		9*	15*	1*	17*	1	17	ns	
<sup>t</sup> PHL		Q	GL = 13 pr		9*	15*	1*	17*	1	17	115	
<sup>t</sup> PZH	ŌĒ	Q	C 15 pE		8*	13*	1*	15*	1	15	ns	
tPZL		OE	Q	C <sub>L</sub> = 15 pF		8*	13*	1*	15*	1	15	115
<sup>t</sup> PHZ	<del></del>	Q	C <sub>I</sub> = 15 pF		9*	14*	1*6	16*	1	16	ns	
t <sub>PLZ</sub>	ŌĒ	OE	<u> </u>	OL = 13 pi		10*	14*	1/*	16*	1	16	115
<sup>t</sup> PLH	CLK	Q	$C_1 = 50  pF$		10.6	16.2	201	18.5	1	18.5	ns	
<sup>t</sup> PHL	OLIX	Q	С_ = 50 рі		10.6	16.2	Q 1	18.5	1	18.5	115	
<sup>t</sup> PZH	ŌE	Q	C <sub>L</sub> = 50 pF		9.6	14.9	1	16	1	16	ns	
tPZL	OE	Q	CL = 30 pr		9.6	14.9	1	16	1	16	115	
<sup>t</sup> PHZ	ŌĒ	Q	C <sub>I</sub> = 50 pF		10.2	15.5	1	17	1	17	ns	
tPLZ	OE	Ų.	OL = 30 bi-		11.8	15.5	1	17	1	17	119	
tsk(o)			C <sub>L</sub> = 50 pF			1.5**				1.5	ns	

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.

## switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T,	<sub>Δ</sub> = 25°C	;	SN54AH	C16374	SN74AHC	16374	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
f			C <sub>L</sub> = 15 pF	130*	185*		110*		110		MHz
fmax			C <sub>L</sub> = 50 pF	85	120		75		75		IVITIZ
tPLH	CLK	Q	C <sub>I</sub> = 15 pF		5.4*	9.1*	1*	10.1*	1	10.1	ns
<sup>t</sup> PHL	CLN	Q	CL = 15 pr		5.4*	9.1*	1*	10.1*	1	10.1	115
<sup>t</sup> PZH	ŌĒ	Q	C <sub>L</sub> = 15 pF		5.1*	9.1*	1*	10.1*	1	10.1	ns
tPZL	OE OE	Q	CL = 15 pr		5.1*	9.1*	1*	10.1*	1	10.1	115
t <sub>PHZ</sub>	<u></u>	Q	C <sub>I</sub> = 15 pF		5*	9.5*	1*2	10.5*	1	10.5	ns
tPLZ	ŌĒ	Q	CL = 13 pr		5*	9.5*	1/4	10.5*	1	10.5	115
t <sub>PLH</sub>	CLK	Q	C <sub>I</sub> = 50 pF		6.9	10.1	31	11.5	1	11.5	ns
t <sub>PHL</sub>	OLK	Q	CL = 30 pr		6.9	10.1	Q 1	11.5	1	11.5	115
<sup>t</sup> PZH	ŌĒ	Q	C <sub>I</sub> = 50 pF		6.6	10.1	1	11.5	1	11.5	ns
t <sub>PZL</sub>	OE	Q	CL = 30 pr		6.6	10.1	1	11.5	1	11.5	115
t <sub>PHZ</sub>	ŌĒ	Q	C <sub>I</sub> = 50 pF		6.1	10.5	1	11.5	1	11.5	ns
t <sub>PLZ</sub>	OE	ď	OL = 30 pr		6.1	10.5	1	11.5	1	11.5	115
tsk(o)			C <sub>L</sub> = 50 pF			1**				1	ns

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter is not production tested.



<sup>\*\*</sup> On products compliant to MIL-PRF-38535, this parameter does not apply.

<sup>\*\*</sup> On products compliant to MIL-PRF-38535, this parameter does not apply.

### SN54AHC16374, SN74AHC16374 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

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### noise characteristics, $V_{CC}$ = 5 V, $C_L$ = 50 pF, $T_A$ = 25°C (see Note 4)

	PARAMETER	SN74	UNIT		
	PARAMETER	MIN	TYP	MAX	UNIT
V <sub>OL(P)</sub>	Quiet output, maximum dynamic V <sub>OL</sub>		0.36	0.8	V
V <sub>OL</sub> (V)	Quiet output, minimum dynamic V <sub>OL</sub>		-0.16	-0.8	V
VOH(V)	Quiet output, minimum dynamic VOH		4.6		V
VIH(D)	High-level dynamic input voltage	3.5			V
V <sub>IL(D)</sub>	Low-level dynamic input voltage			1.5	V

NOTE 4: Characteristics are for surface-mount packages only.

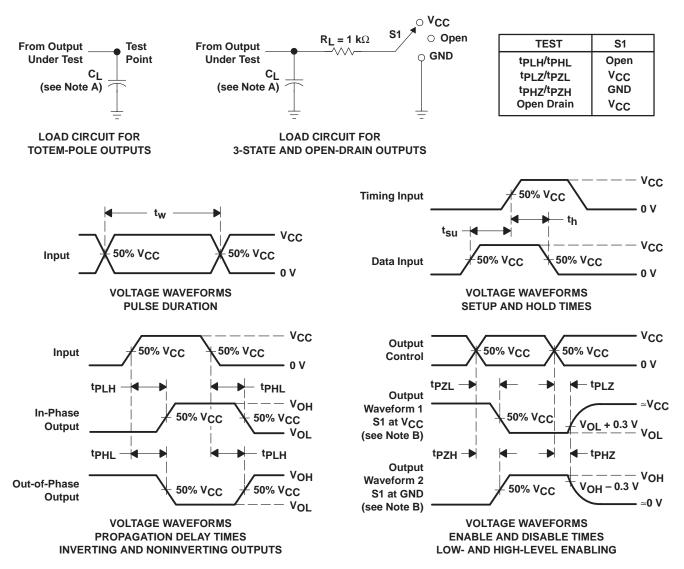
### operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

	PARAMETER	TEST C	ONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance	No load,	f = 1 MHz	32	pF



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#### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50~\Omega$ ,  $t_f \leq 3$  ns,  $t_f \leq 3$  ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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